

#### **Features**

- Top view 1016 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Green
- RoHS compliance

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### **Description**

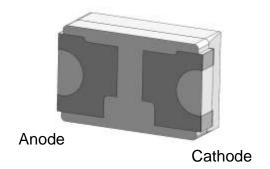
The HGC101606-ATC4 is an AlGaInP Green LED housed in a miniature SMD package. The device has a dominant wavelength of 525nm LED.

## **Applications**

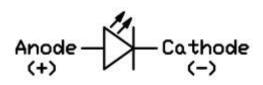
- Optical indicator.
- Switch and Symbol Display.

### **Package Outline**





#### **Schematic**





### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
l <sub>F</sub>	Continuous Forward Current	30	mA	
I <sub>FP</sub>	Peak Forward Current	130	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	100	mW	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =20mA	1420	-	2850	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =20mA	520	•	530	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =20mA	-	±60	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =20mA	2.7	-	3.3	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

#### Notes:

- 1. IFP Conditions--Pulse Width $\leq$  100 $\mu$ s and Duty $\leq$  10%.
- 2. Soldering time  $\leq 10$  seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
W2	1420	1800		
X1	1800	2250	mcd	I <sub>F</sub> =20mA
X2	2250	2850		

Tolerance of Luminous Intensity  $\pm 10\%$ 



#### 4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
A5	520	525	nm	I20mΛ
A6	525	530	nm	I <sub>F</sub> =20mA

Tolerance of Dominant Wavelength: ±1nm.

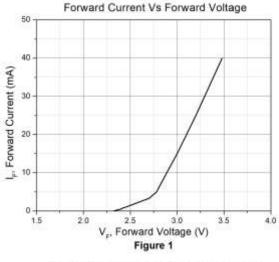
#### 5. Bin Range of Forward Voltage

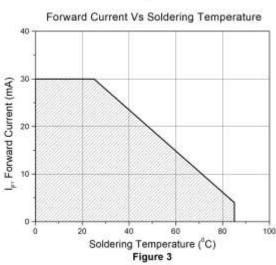
Bin Code	Min	Max	Unit	Condition
V9	2.7	2.9		
V10	2.9	3.1	V	I <sub>F</sub> =20mA
V11	3.1	3.3		

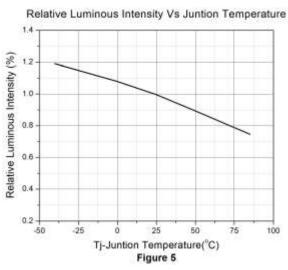
Tolerance of Forward Voltage  $\pm 0.1$ V.

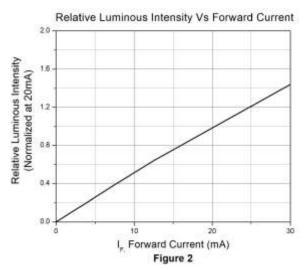


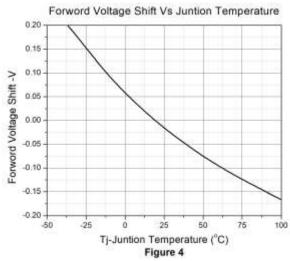
## **Typical Characteristic Curves**

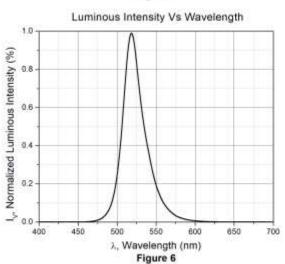






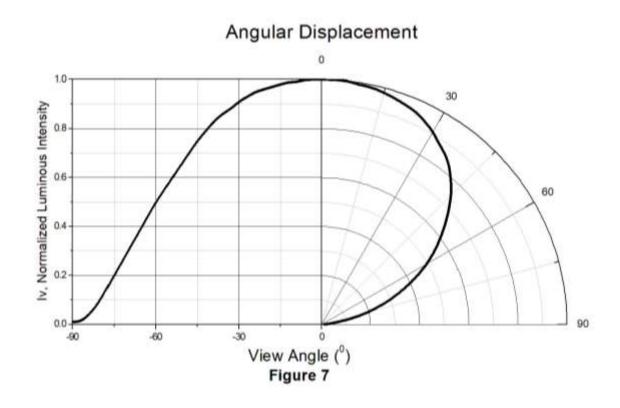






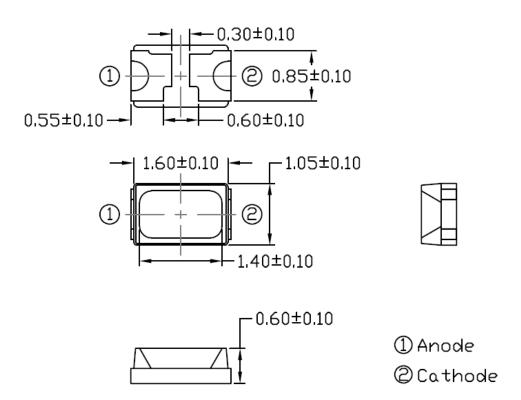


## **Typical Characteristic Curves**



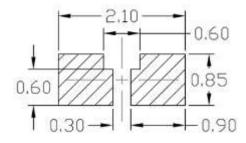


### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

## Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



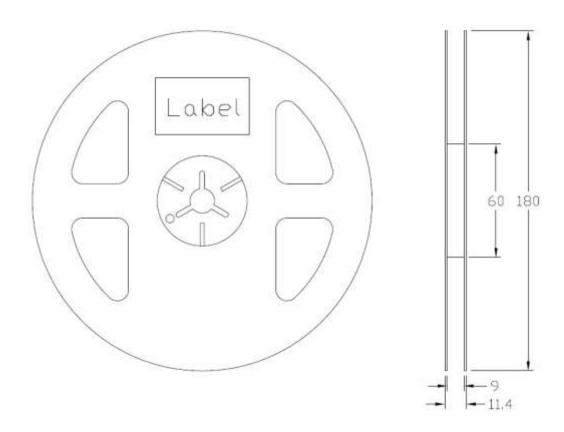
Note: Tolerance unless mentioned is ±0.1mm.

## **Ordering Information**

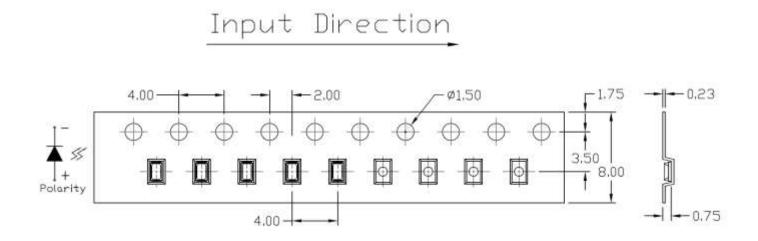
Part Number	Description	Quantity
HGC101606-ATC4	Tape & Reel	4000 pcs



#### Reel Dimension All dimensions are in mm, unless otherwise stated



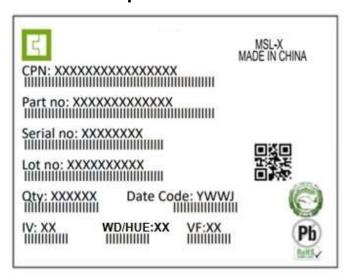
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



#### **Label Form Specification**



CPN : Customer Part Number
Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date IV: Bin Code of Luminous Intensity

WD: Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

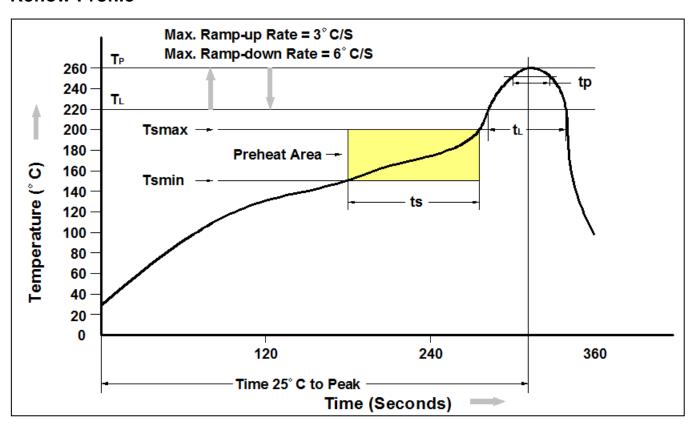
MADE IN CHINA: Production Place

### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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